

EL7155

High Performance Pin Driver

FN7279
Rev 3.00
October 24, 2014

The EL7155 high performance pin driver with 3-state is suited to many ATE and level-shifting applications. The 3.5A peak drive capability makes this part an excellent choice when driving high capacitance loads.

Output pins OUT_H and OUT_L are connected to input pins V_H and V_L respectively, depending on the status of the IN pin. One of the output pins is always in tri-state, except when the OE pin is low, in which case both outputs are in tri-state mode. The isolation of the output FETs from the power supplies enables V_H and V_L to be set independently, enabling level-shifting to be implemented.

This pin driver has improved performance over existing pin drivers. It is specifically designed to operate at voltages down to 0V across the switch elements while maintaining good speed and ON-resistance characteristics.

Available in an 8 Ld SOIC package, the EL7155 is specified for operation over the full -40°C to $+85^{\circ}\text{C}$ temperature range.

Features

- Clocking speeds up to 40MHz
- 15ns tr/tf at 2000pF C_{LOAD}
- 0.5ns rise and fall times mismatch
- 0.5ns t_{ON} - t_{OFF} prop delay mismatch
- 3.5pF typical input capacitance
- 3.5A peak drive
- Low ON-resistance of 3.5Ω
- High capacitive drive capability
- Operates from 4.5V up to 16.5V
- Pb-free (RoHS compliant)

Applications

- ATE/burn-in testers
- Level shifting
- IGBT drivers
- CCD drivers

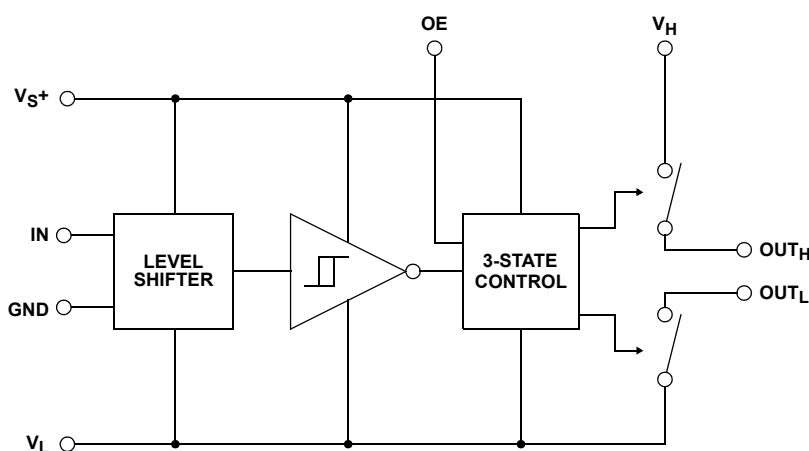
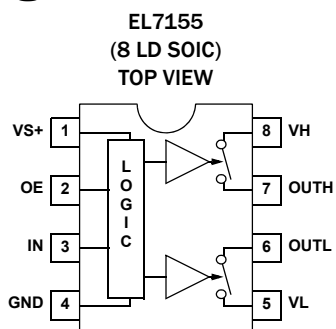


FIGURE 1. BLOCK DIAGRAM

Pin Configuration



Pin Descriptions

PIN #	PIN NAME	FUNCTION	EQUIVALENT CIRCUIT
1	VS+	Positive Supply Voltage	
2	OE	Output Enable	Circuit 1
3	IN	Input	Reference Circuit 1
4	GND	Ground	
5	VL	Negative Supply and Lower Output Voltage	
6	OUTL	Lower Switch Output	Circuit 2
7	OUTH	Upper Switch Output	Circuit 3
8	VH	Upper Output Voltage	

Ordering Information

PART NUMBER (Notes 1, 2)	PART MARKING	PACKAGE (Pb-Free)	PKG. DWG. #
EL7155CSZ	7155CSZ	8 Ld SOIC	M8.15E
EL7155CSZ-T7 (Note 3)	7155CSZ	8 Ld SOIC	M8.15E
EL7155CSZ-T7A (Note 3)	7155CSZ	8 Ld SOIC	M8.15E
EL7155CSZ-T13 (Note 3)	7155CSZ	8 Ld SOIC	M8.15E

NOTE:

- Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- For Moisture Sensitivity Level (MSL), please see product information page for [EL7155](#). For more information on MSL, please see tech brief [TB363](#).
- Please refer to [TB347](#) for details on reel specifications.

Absolute Maximum Ratings ($T_A = +25^\circ\text{C}$)

Supply Voltage (V_S+ to V_L) +18V
 V_H - V_L , V_H to GND, V_S+ to V_H 16.5V
 Input Voltage -0.3V below V_L to +0.3V above V_S
 Continuous Output Current 200mA
 Storage Temperature Range -65°C to $+150^\circ\text{C}$

Thermal Information

Ambient Operating Temperature -40°C to $+85^\circ\text{C}$
 Operating Junction Temperature $+125^\circ\text{C}$
 Power Dissipation see curves
 Pb-Free Reflow Profile see [TB493](#)

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

Electrical Specifications $V_S+ = +15\text{V}$, $V_H = +15\text{V}$, $V_L = 0\text{V}$, $T_A = +25^\circ\text{C}$, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$, unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	MIN (Note 4)	TYP (Note 5)	MAX (Note 4)	UNITS
INPUT						
V_{IH}	Logic '1' Input Voltage		2.4			V
I_{IH}	Logic '1' Input Current	$V_{IH} = V_S+$		0.1	10	μA
V_{IL}	Logic '0' Input Voltage				0.8	V
I_{IL}	Logic '0' Input Current	$V_{IL} = 0\text{V}$		0.1	10	μA
C_{IN}	Input Capacitance			3.5		pF
R_{IN}	Input Resistance			50		M Ω
OUTPUT						
R_{OVH}	ON-Resistance V_H to OUT_H	$I_{OUT} = -200\text{mA}$		2.7	4.5	Ω
R_{OVL}	ON-Resistance V_L to OUT_L	$I_{OUT} = +200\text{mA}$		3.5	5.5	Ω
I_{OUT}	Output Leakage Current	$OE = 0\text{V}$, $OUT_H = V_L$, $OUT_L = V_S+$		0.1	10	μA
I_{PK}	Peak Output Current (linear resistive operation)	Source		3.5		A
		Sink		3.5		A
I_{DC}	Continuous Output Current	Source/Sink	200			mA
POWER SUPPLY						
I_S	Power Supply Current	Inputs = V_S+		1.3	3	mA
I_{VH}	Off Leakage at V_H	$V_H = 0\text{V}$		4	10	μA
SWITCHING CHARACTERISTICS						
t_R	Rise Time	$C_L = 2000\text{pF}$		14.5		ns
t_F	Fall Time	$C_L = 2000\text{pF}$		15		ns
$t_{RF\Delta}$	t_R , t_F Mismatch	$C_L = 2000\text{pF}$		0.5		ns
t_{D-1}	Turn-Off Delay Time	$C_L = 2000\text{pF}$		9.5		ns
t_{D-2}	Turn-On Delay Time	$C_L = 2000\text{pF}$		10		ns
$t_{D\Delta}$	t_{D-1} - t_{D-2} Mismatch	$C_L = 2000\text{pF}$		0.5		ns
t_{D-3}	3-state Delay Enable			10		ns
t_{D-4}	3-state Delay Disable			10		ns

Electrical Specifications $V_{S+} = +5V$, $V_H = +5V$, $V_L = -5V$, $T_A = +25^\circ C$, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$, unless otherwise specified.

PARAMETER	DESCRIPTION	CONDITION	MIN (Note 4)	TYP (Note 5)	MAX (Note 4)	UNIT
INPUT						
V_{IH}	Logic '1' Input Voltage		2.0			V
I_{IH}	Logic '1' Input Current	$V_{IH} = V_{S+}$		0.1	10	μA
V_{IL}	Logic '0' Input Voltage				0.8	V
I_{IL}	Logic '0' Input Current	$V_{IL} = 0V$		0.1	10	μA
C_{IN}	Input Capacitance			3.5		pF
R_{IN}	Input Resistance			50		M Ω
OUTPUT						
R_{OVH}	ON-Resistance V_H to OUT_H	$I_{OUT} = -200mA$		3.4	5	Ω
R_{OVL}	ON-Resistance V_L to OUT_L	$I_{OUT} = +200mA$		4	6	Ω
I_{OUT}	Output Leakage Current	$OE = 0V$, $OUT_H = V_L$, $OUT_L = V_{S+}$		0.1	10	μA
I_{PK}	Peak Output Current (linear resistive operation)	Source		3.5		A
		Sink		3.5		A
I_{DC}	Continuous Output Current	Source/Sink	200			mA
POWER SUPPLY						
I_S	Power Supply Current	Inputs = V_{S+}		1	2.5	mA
I_{VH}	Off Leakage at V_H	$V_H = 0V$		4	10	μA
SWITCHING CHARACTERISTICS						
t_R	Rise Time	$C_L = 2000pF$		17		ns
t_F	Fall Time	$C_L = 2000pF$		17		ns
$t_{RF\Delta}$	t_R , t_F Mismatch	$C_L = 2000pF$		0		ns
t_{D-1}	Turn-Off Delay Time	$C_L = 2000pF$		11.5		ns
t_{D-2}	Turn-On Delay Time	$C_L = 2000pF$		12		ns
$t_{D\Delta}$	t_{D-1} - t_{D-2} Mismatch	$C_L = 2000pF$		0.5		ns
t_{D-3}	3-state Delay Enable			11		ns
t_{D-4}	3-state Delay Disable			11		ns

NOTES:

- Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.
- Typical values are for information purposes only.

Typical Performance Curves

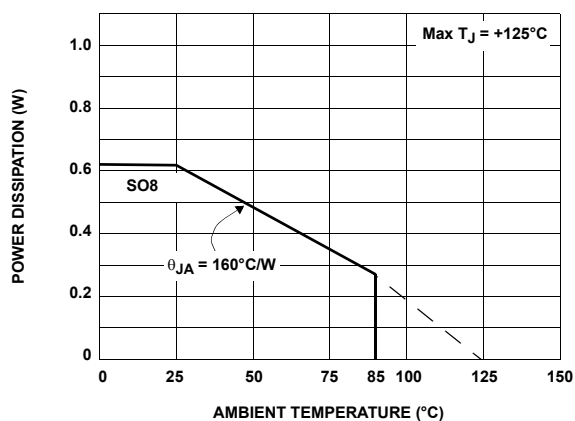


FIGURE 2. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE JEDEC JESD51-3 LOW EFFECTIVE THERMAL CONDUCTIVITY TEST BOARD

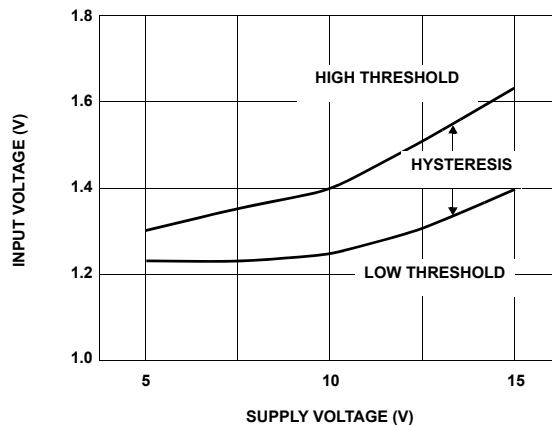


FIGURE 3. INPUT THRESHOLD vs SUPPLY VOLTAGE, $T = 25^{\circ}\text{C}$

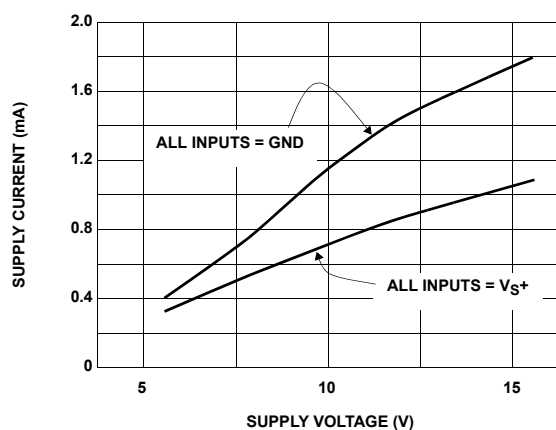


FIGURE 4. QUIESCENT SUPPLY CURRENT vs SUPPLY VOLTAGE, $T = +25^{\circ}\text{C}$

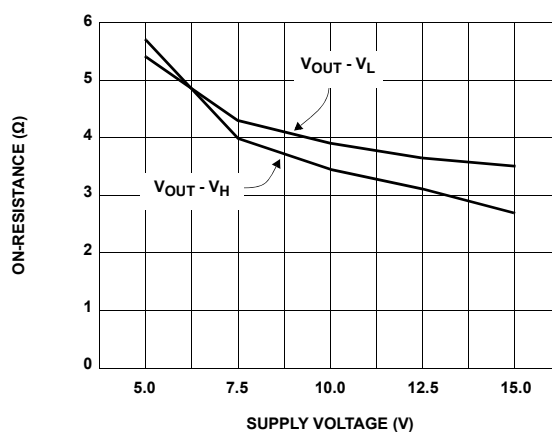


FIGURE 5. ON-RESISTANCE vs SUPPLY VOLTAGE, $I_{\text{OUT}} = 200\text{mA}$, $T = +25^{\circ}\text{C}$, $V_{\text{S+}} = V_{\text{H}}$, $V_{\text{L}} = 0\text{V}$

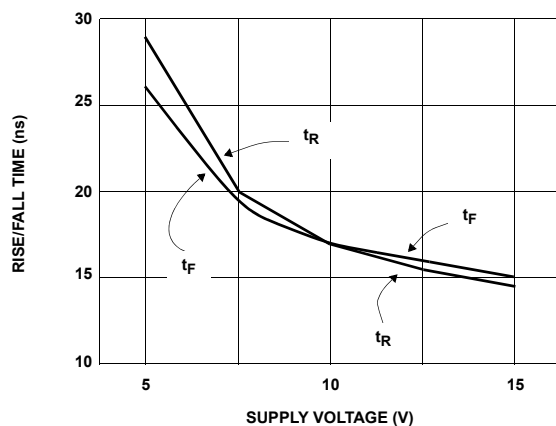


FIGURE 6. RISE/FALL TIME vs SUPPLY VOLTAGE
 $C_{\text{L}} = 2000\text{pF}$, $T = +25^{\circ}\text{C}$

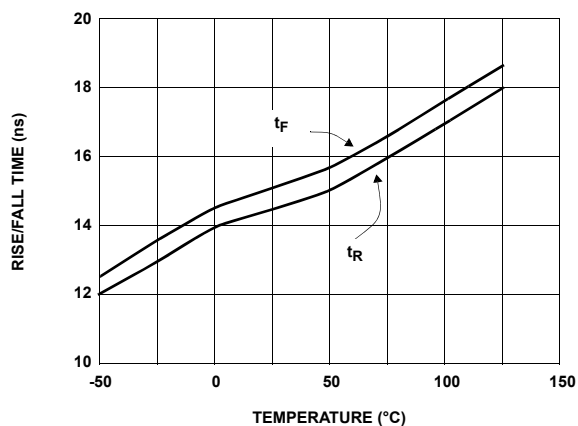


FIGURE 7. RISE/FALL TIME vs TEMPERATURE
 $C_{\text{L}} = 2000\text{PF}$, $V_{\text{S+}} = 15\text{V}$

Typical Performance Curves (Continued)

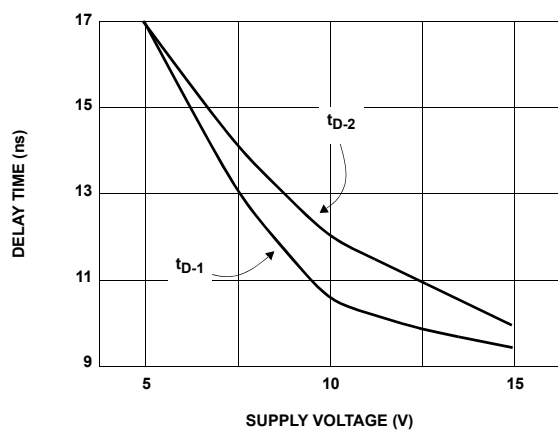


FIGURE 8. PROPAGATION DELAY vs SUPPLY VOLTAGE
 $C_L = 2000\text{pF}$, $T = +25^\circ\text{C}$

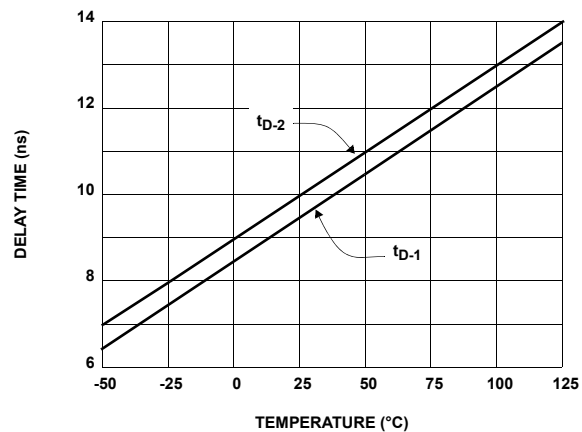


FIGURE 9. PROPAGATION DELAY vs TEMPERATURE
 $C_L = 2000\text{pF}$, $V_{S+} = 15\text{V}$

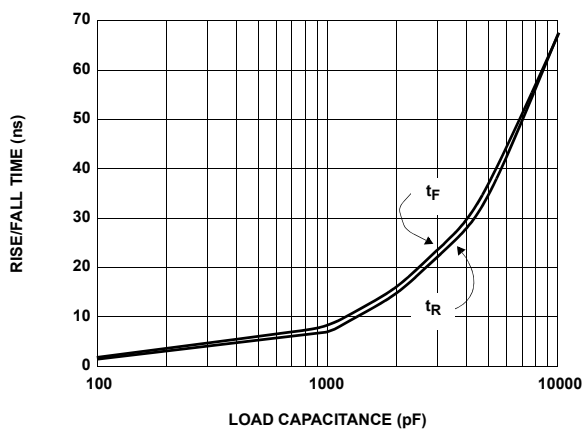


FIGURE 10. RISE/FALL TIME vs LOAD CAPACITANCE
 $V_{S+} = +15\text{V}$, $T = +25^\circ\text{C}$

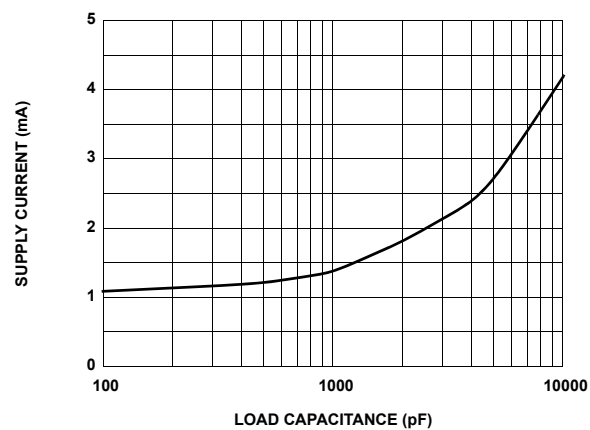


FIGURE 11. SUPPLY CURRENT vs LOAD CAPACITANCE,
 $V_{S+} = V_H = 15\text{V}$, $V_L = 0\text{V}$, $T = +25^\circ\text{C}$, $f = 20\text{kHz}$

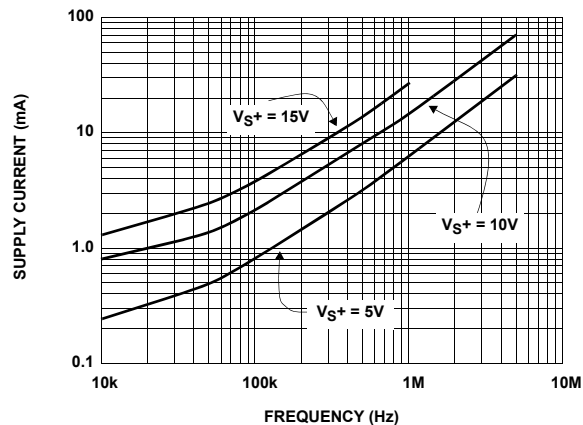


FIGURE 12. SUPPLY CURRENT vs FREQUENCY, $C_L = 1000\text{pF}$, $T = +25^\circ\text{C}$

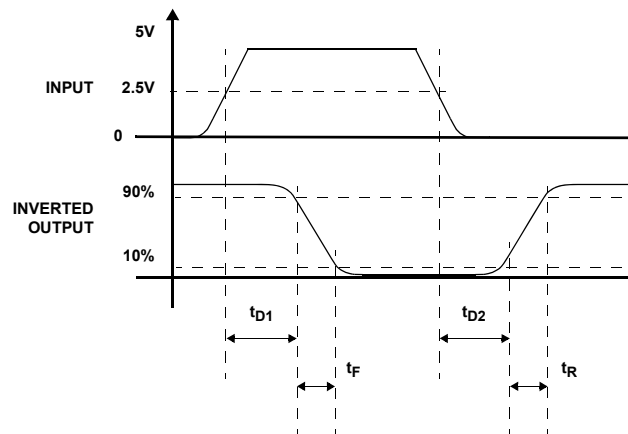
TABLE 1. TRUTH TABLE

OE	IN	V _H to OUT _H	OUT _L to V _L
0	0	Open	Open
0	1	Open	Open
1	0	Closed	Open
1	1	Open	Closed

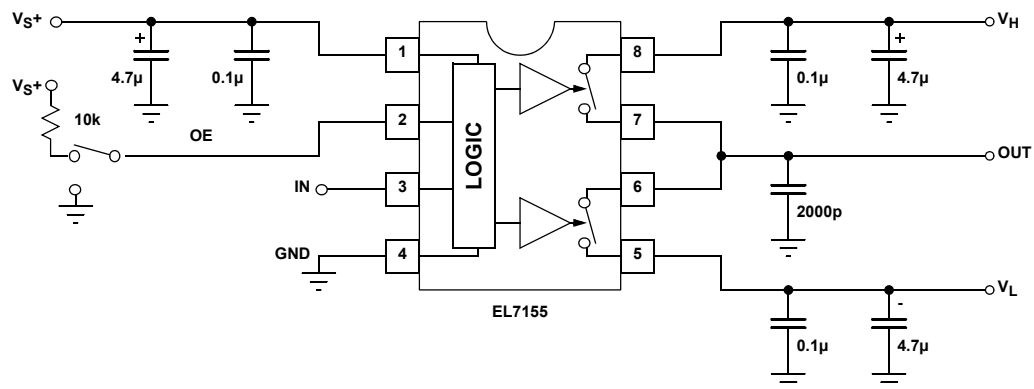
TABLE 2. OPERATING VOLTAGE RANGE

PIN	MIN (V)	MAX (V)
$V_L - GND$	-5	0
$V_{S^+} - V_L$	5	16.5
$V_H - V_L$	0	16.5
$V_{S^+} - V_H$	0	16.5
$V_{S^+} - GND$	5	16.5
3-State Output	V_L	V_H

TimingDiagrams



Standard Test Configuration



Applications Information

Product Description

The EL7155 is a high performance 40MHz pin driver. It contains two analog switches connecting V_H to OUT_H and V_L to OUT_L . Depending on the value of the IN pin, one of the two switches will be closed and the other switch open. An output enable (OE) is also supplied, which opens both switches simultaneously.

Due to the topology of the EL7155, V_L should always be connected to a voltage equal to or lower than GND. V_H can be connected to any voltage between V_L and the positive supply, V_{S+} .

The EL7155 is available in the 8 Ld SOIC package. Application dependent power dissipation should be calculated to ensure that the maximum junction temperature isn't violated.

3-state Operation

When the OE pin is low, the output is 3-state (floating.) The disabled output voltage is the parasitic capacitance's voltage. It can be any voltage between V_H and V_L , depending on the previous state. At 3-state, the output voltage can be driven to any voltage between V_H and V_L . The output voltage can't be driven higher than V_H or lower than V_L since the body diode at the output stage will turn on.

Supply Voltage Range and Input Compatibility

The EL7155 is designed for operation on supplies from 5V to 15V (4.5V to 16.5V maximum). [Table 2 on page 7](#) shows the specifications for the relationship between the V_{S+} , V_H , V_L , and GND pins.

All input pins are compatible with both 3V and 5V CMOS signals. With a positive supply (V_{S+}) of 5V, the EL7155 is also compatible with TTL inputs.

Power Supply Bypassing

When using the EL7155, it is very important to use adequate power supply bypassing. The high switching currents developed by the EL7155 necessitate the use of a bypass capacitor between the V_{S+} and GND pins. It is recommended that a 2.2 μ F tantalum capacitor be used in parallel with a 0.1 μ F low-inductance ceramic MLC capacitor. These should be placed as close to the supply pins as possible. It is also recommended that the V_H and V_L pins have some level of bypassing, especially if the EL7155 is driving highly capacitive loads.

Power Dissipation Calculation

When switching at high speeds, or driving heavy loads, the EL7155 drive capability is limited by the rise in die temperature brought about by internal power dissipation. For reliable operation die temperature must be kept below T_{JMAX} (+125°C). It is necessary to calculate the power dissipation for a given application prior to selecting the package type.

Power dissipation may be calculated:

$$PD = (V_S \times I_S) + (C_{INT} \times V_S^2 \times f) + (C_L \times V_{OUT}^2 \times f) \quad (EQ. 1)$$

where:

V_S is the total power supply to the EL7155 (from V_{S+} to GND)

V_{OUT} is the swing on the output ($V_H - V_L$)

C_L is the load capacitance

C_{INT} is the internal load capacitance (100pF max)

I_S is the quiescent supply current (3mA max)

f is frequency

Having obtained the application's power dissipation, a maximum package thermal coefficient may be determined, to maintain the internal die temperature below T_{JMAX} :

$$\theta_{JA} = \frac{(T_{JMAX} - T_{MAX})}{PD} \quad (EQ. 2)$$

where:

T_{JMAX} is the maximum junction temperature (+125°C)

T_{MAX} is the maximum operating temperature

PD is the power dissipation calculated above

θ_{JA} thermal resistance on junction to ambient

θ_{JA} is 160°C/W for the SO8 package when using a standard JEDEC JESD51-3 single-layer test board. If T_{JMAX} is greater than +125°C when calculated using the [Equation 2](#), then one of the following actions must be taken:

1. Reduce θ_{JA} the system by designing more heatsinking into the PCB (as compared to the standard JEDEC JESD51-3).
2. Derate the application either by reducing the switching frequency, the capacitive load, or the maximum operating (ambient) temperature (T_{MAX}).

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

DATE	REVISION	CHANGE
October 24, 2014	FN7279.3	Updated datasheet to new Intersil template. Updated the Ordering Information table on page 2 by removing the obsolete products and adding the -T7A part. Added revision history and about Intersil.

About Intersil

Intersil Corporation is a leading provider of innovative power management and precision analog solutions. The company's products address some of the largest markets within the industrial and infrastructure, mobile computing and high-end consumer markets.

For the most updated datasheet, application notes, related documentation and related parts, please see the respective product information page found at www.intersil.com.

You may report errors or suggestions for improving this datasheet by visiting www.intersil.com/ask.

Reliability reports are also available from our website at www.intersil.com/support

© Copyright Intersil Americas LLC 2003-2014. All Rights Reserved.
All trademarks and registered trademarks are the property of their respective owners.

For additional products, see www.intersil.com/en/products.html

Intersil products are manufactured, assembled and tested utilizing ISO9001 quality systems as noted in the quality certifications found at www.intersil.com/en/support/qualandreliability.html

Intersil products are sold by description only. Intersil may modify the circuit design and/or specifications of products at any time without notice, provided that such modification does not, in Intersil's sole judgment, affect the form, fit or function of the product. Accordingly, the reader is cautioned to verify that datasheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

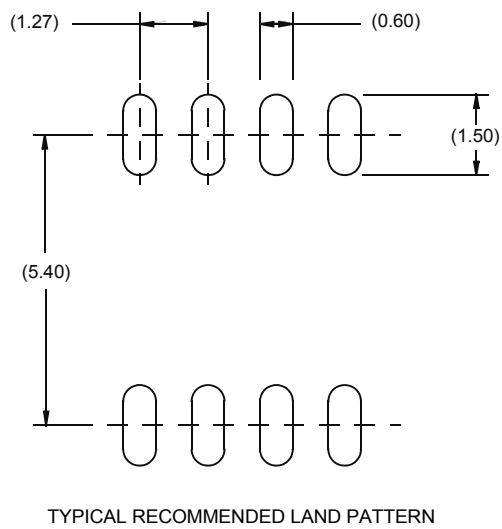
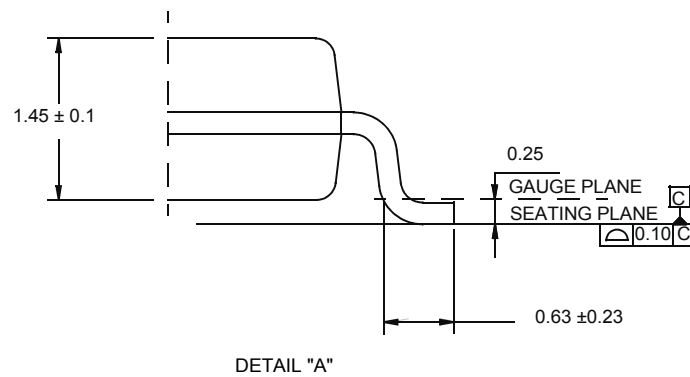
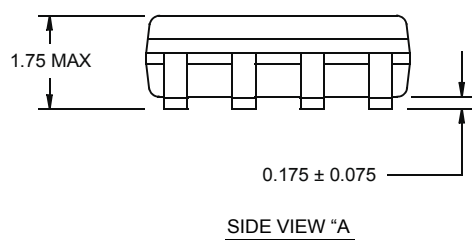
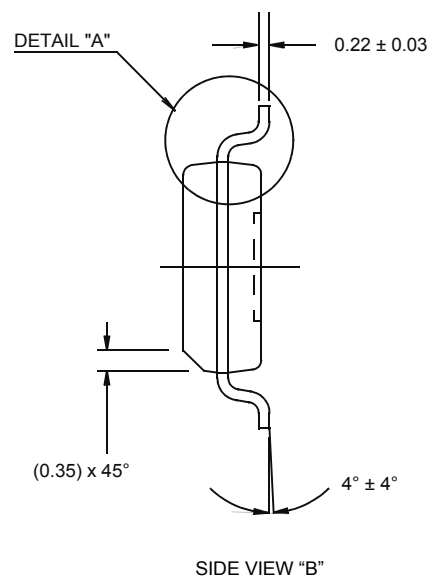
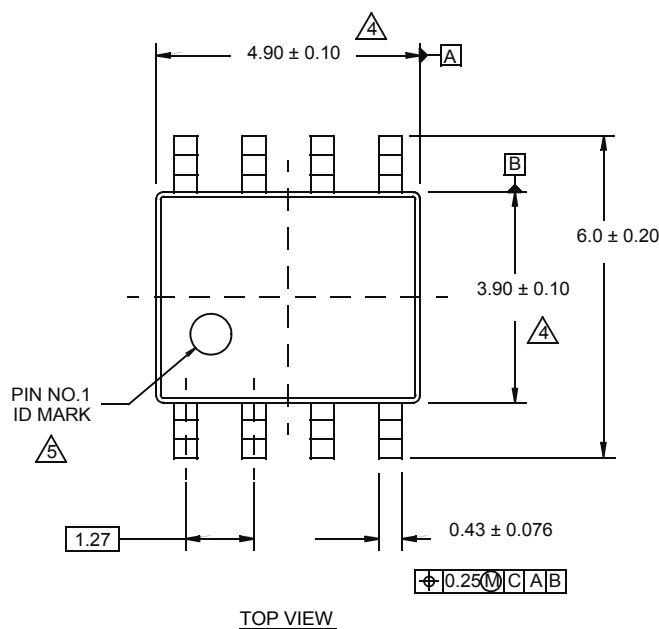
For information regarding Intersil Corporation and its products, see www.intersil.com

Package Outline Drawing

M8.15E

8 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

Rev 0, 08/09



NOTES:

1. Dimensions are in millimeters.
Dimensions in () for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal ± 0.05
4. Dimension does not include interlead flash or protrusions.
Interlead flash or protrusions shall not exceed 0.25mm per side.
5. The pin #1 identifier may be either a mold or mark feature.
6. Reference to JEDEC MS-012.

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А